

LED Display
Product Data Sheet
LTS-4817SW-P

Spec No. :DS30-2011-0178
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LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

LED DISPLAY LTS-4817SW-P

LED DISPLAY

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<u>Rev</u>	<u>Description</u>	<u>By</u>	<u>Date</u>
01	Preliminary Spec.	Reo Lin	08/24/2011
02	2.1 Modify packing dimension 2.2 Modify recommended soldering pattern	Reo Lin	09/21/2011
Above data for PD and Customer tracking only			
-	NPPR Received and Upload on System	Reo Lin	09/21/2011
A	Update Packing spec. in page 12	Reo Lin	01/06/2020
B	Add item 10	Erin Cheng	06/19/2024

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1. Description

The LTS-4817SW-P is a 0.39 inch (10.0mm) digit height single digit SMD display. This device uses InGaN white chip LED, which are made from InGaN on a Sapphire substrate. The display has gray face and white segments and suitable for reverse mount assembly.

1.1 Features

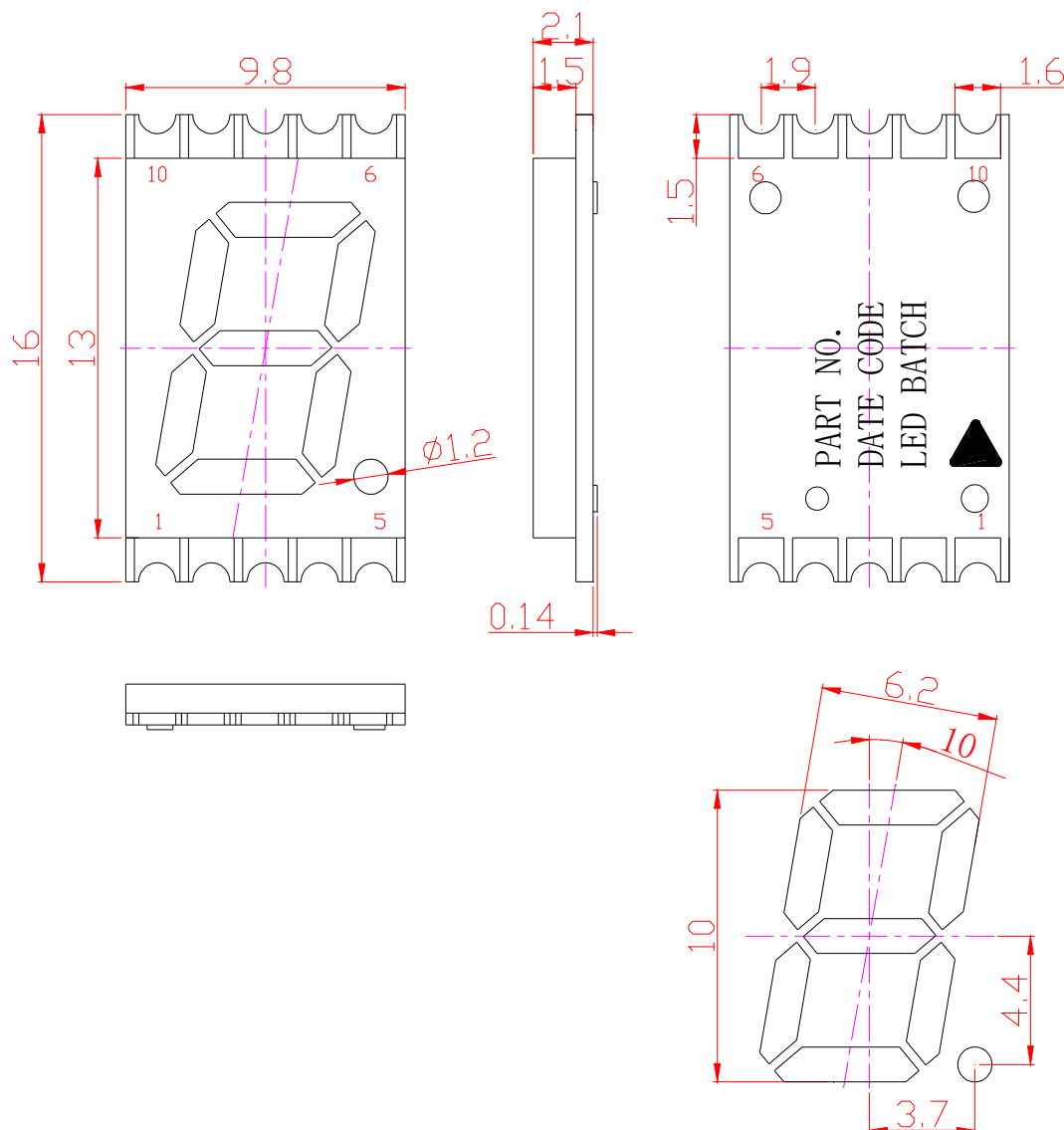
- 0.39 inch (10.0 mm) DIGIT HEIGHT
- CONTINUOUS UNIFORM SEGMENTS
- LOW POWER REQUIREMENT
- EXCELLENT CHARACTERS APPEARANCE
- HIGH BRIGHTNESS & HIGH CONTRAST
- WIDE VIEWING ANGLE
- SOLID STATE RELIABILITY
- CATEGORIZED FOR LUMINOUS INTENSITY.
- LEAD-FREE PACKAGE (ACCORDING TO ROHS)

1.2 Device

Part No	Description
InGaN White	Common Anode
LTS-4817SW-P	Rt. Hand Decimal

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2. Package Dimensions

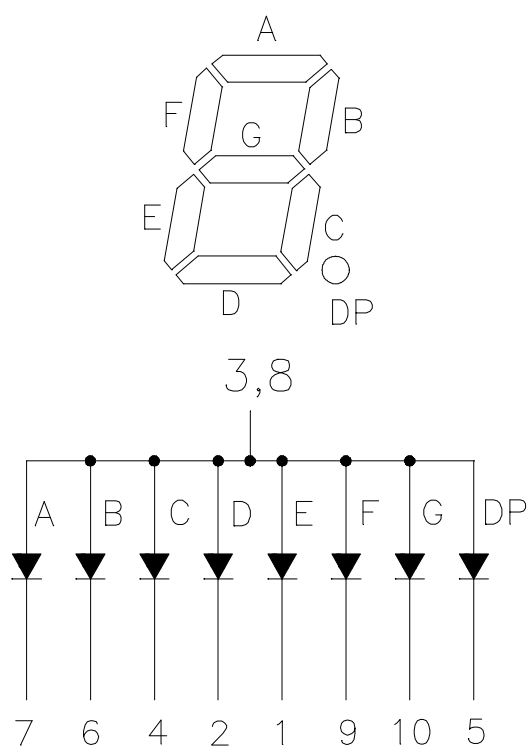


Notes :

1. All dimensions are in millimeters. Tolerances are ± 0.25 mm (0.01") unless otherwise noted
2. Foreign material on segment ≤ 10 mil
3. Ink contamination (surface) ≤ 20 mils
4. Bubble in segment ≤ 10 mil
5. Bending $\leq 1\%$ of reflector length
6. Plastic pin's burr max is 0.14 mm

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3. Internal Circuit Diagram



4. Pin Connection

No	Connection
1	CATHODE E
2	CATHODE D
3	COMMON ANODE
4	CATHODE C
5	CATHODE DP
6	CATHODE B
7	CATHODE A
8	COMMON ANODE
9	CATHODE F
10	CATHODE G

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5. Rating and Characteristics

5.1. CHIP LED Absolute Maximum Rating at Ta=25°C

Parameter	Maximum Rating	Unit
Power Dissipation Per Segment	35	mW
Peak Forward Current Per Segment (1/10 Duty Cycle, 0.1ms Pulse Width)	50	mA
Continuous Forward Current Per Segment	10	mA
Derating Linear From 25°C Per Segment	0.11	mA/°C
Operating Temperature Range	-35°C to +105°C	
Storage Temperature Range	-35°C to +105°C	
Iron Soldering Conditions: 1/16 inch Below Seating Plane for 3 Seconds at 260°C		

5.2. Chip LED Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Test Condition
Average Luminous Intensity Per Chip	IV	71		165	mcd	IF=5mA Note 1, 2
Chromaticity Coordinates	x		0.294		nm	IF=5mA Note 3
	y		0.286		nm	
Forward Voltage Per Chip	VF	2.7		3.2	V	IF=5mA
Reverse Current Per Chip ⁽⁴⁾	IR			100	μA	VR=5V
Luminous Intensity Matching Ratio (Similar Light Area)	IV-m			2:1		IF=5mA

Notes :

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
Tolerance is 15%
- The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.
- Caution in ESD:
Static Electricity and surge damages the LED. It is recommend to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- Reverse voltage is only for IR test. It can not continue to operate at this situation.
- Cross talk specification $\leq 2.5\%$
- Tolerance Forward Voltage is ± 0.1 V

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5.3.ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic for N/D as a result of friction between LEDs during storage and handling.

5.4. VF,Iv,Hue Code List "For input chip spec only cannot measure from the display "

VF Spec. Table

VF Bin	Forward Voltage (V) at IF = 5mA	
	MIN.	MAX.
3	2.70	2.80
4	2.80	2.90
5	2.90	3.00
6	3.00	3.10
7	3.10	3.20

Tolerance on each Forward Voltage bin is +/-0.1 volt

IV Spec. Table

IV Bin	Luminous Intensity (mcd) at IF = 5mA	
	Min.	Max.
Q11	71.0	81.0
Q12	81.0	90.0
Q21	90.0	101.0
Q22	101.0	112.0
R11	112.0	129.0
R12	129.0	146.0
R21	146.0	165.0

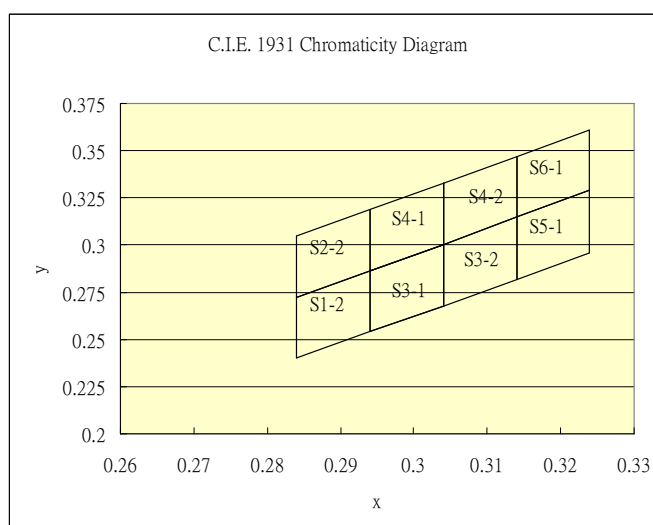
Tolerance on each Luminous Intensity bin is +/- 15%.

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Hue Spec. Table

Hue Bin	Color bin limits at IF = 5mA				
	CIE 1931 Chromaticity coordinates				
S1-2	x	0.284	0.284	0.294	0.294
	y	0.240	0.272	0.286	0.254
S2-2	x	0.284	0.284	0.294	0.294
	y	0.272	0.305	0.319	0.286
S3-1	x	0.294	0.294	0.304	0.304
	y	0.254	0.286	0.300	0.268
S3-2	x	0.304	0.304	0.314	0.314
	y	0.268	0.300	0.315	0.282
S4-1	x	0.294	0.294	0.304	0.304
	y	0.286	0.319	0.333	0.300
S4-2	x	0.304	0.304	0.314	0.314
	y	0.300	0.333	0.347	0.315
S5-1	x	0.314	0.314	0.324	0.324
	y	0.282	0.315	0.329	0.296
S6-1	x	0.314	0.314	0.324	0.324
	y	0.315	0.347	0.361	0.329

Tolerance on each Hue (x, y) bin is +/- 0.01.



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5.5. Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

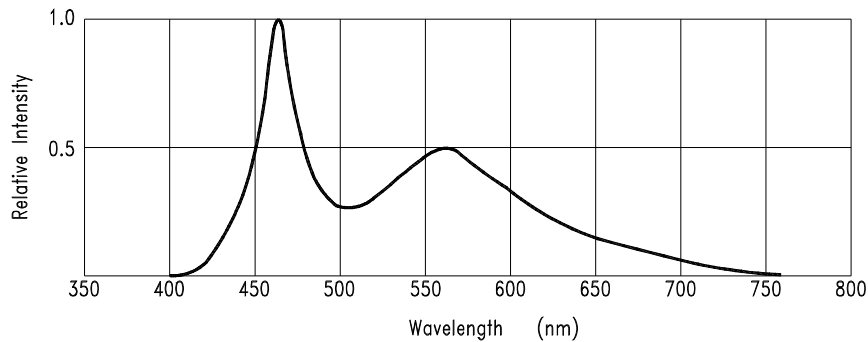


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

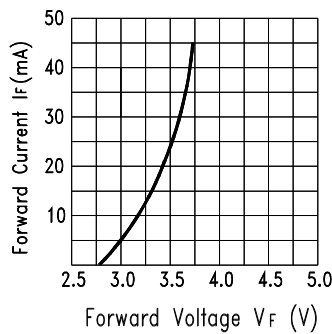


Fig.2 Forward Current vs.
Forward Voltage

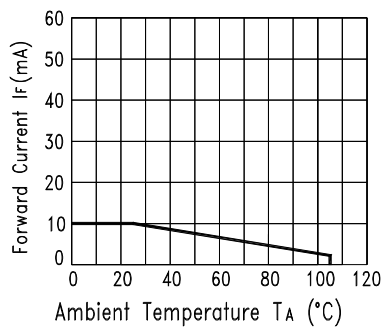


Fig.3 Forward Current
Derating Curve

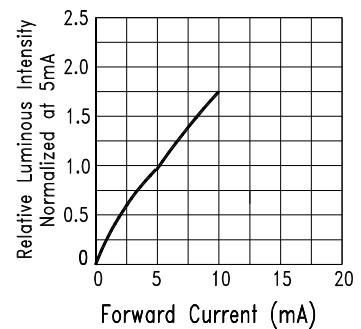


Fig.4 Relative Luminous Intensity
vs. Forward Current

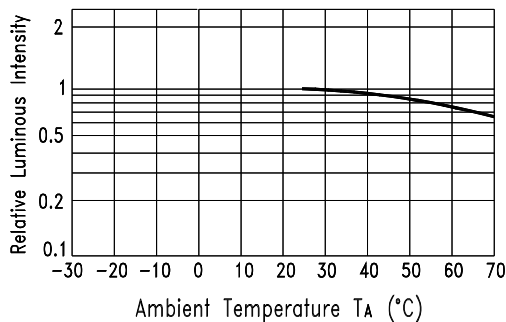


Fig.5 Luminous Intensity vs.
Ambient Temperature

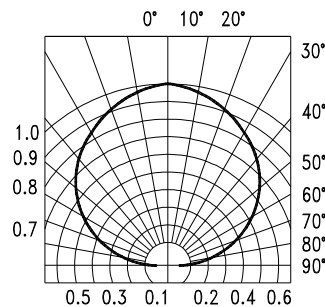


Fig.6 Spatial Distribution

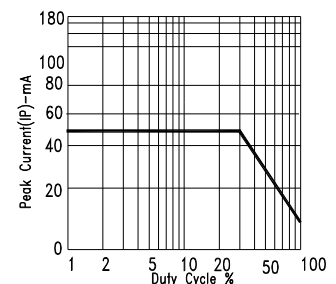
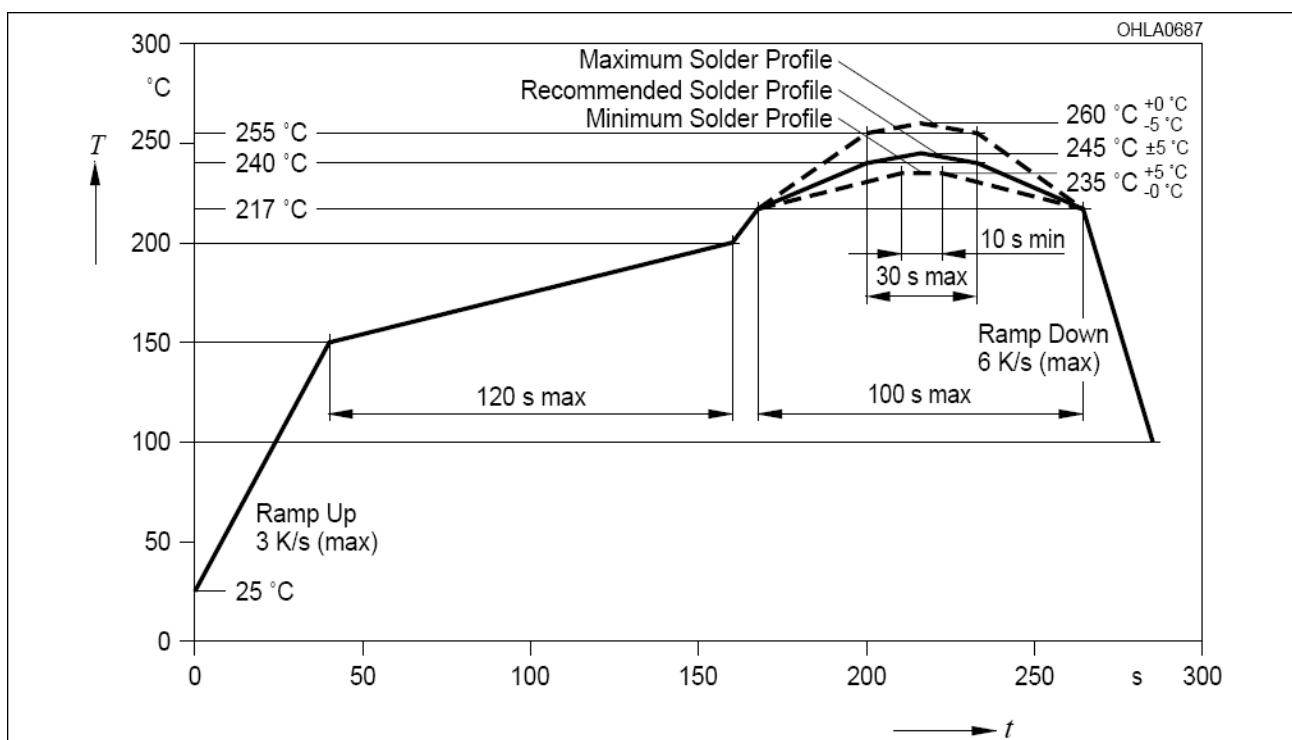


Fig.7 MAX. PEAK CURRENT VS.
DUTY CYCLE %
(REFRESH RATE 1KHz)

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6. SMT SOLDERING INSTRUCTION

(Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process)



Notes :

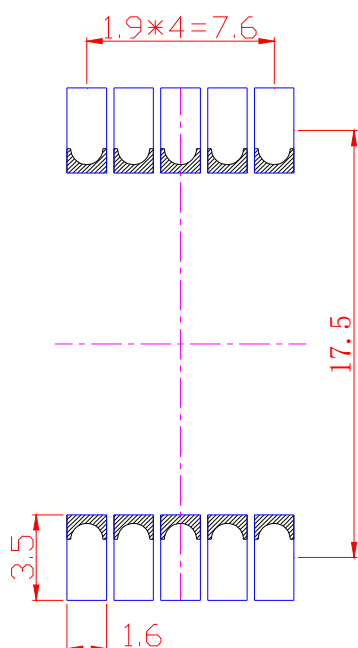
1. Recommended soldering condition

Reflow Soldering (Two times only)		Soldering Iron (One time only)	
Pre-heat:	120~150°C.	Temperature	300°C Max.
Pre-heat time:	120sec. Max.	Soldering time	3sec. Max.
Peak temperature:	260°C Max.		
Soldering time:	5sec. Max.		

2. Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process.

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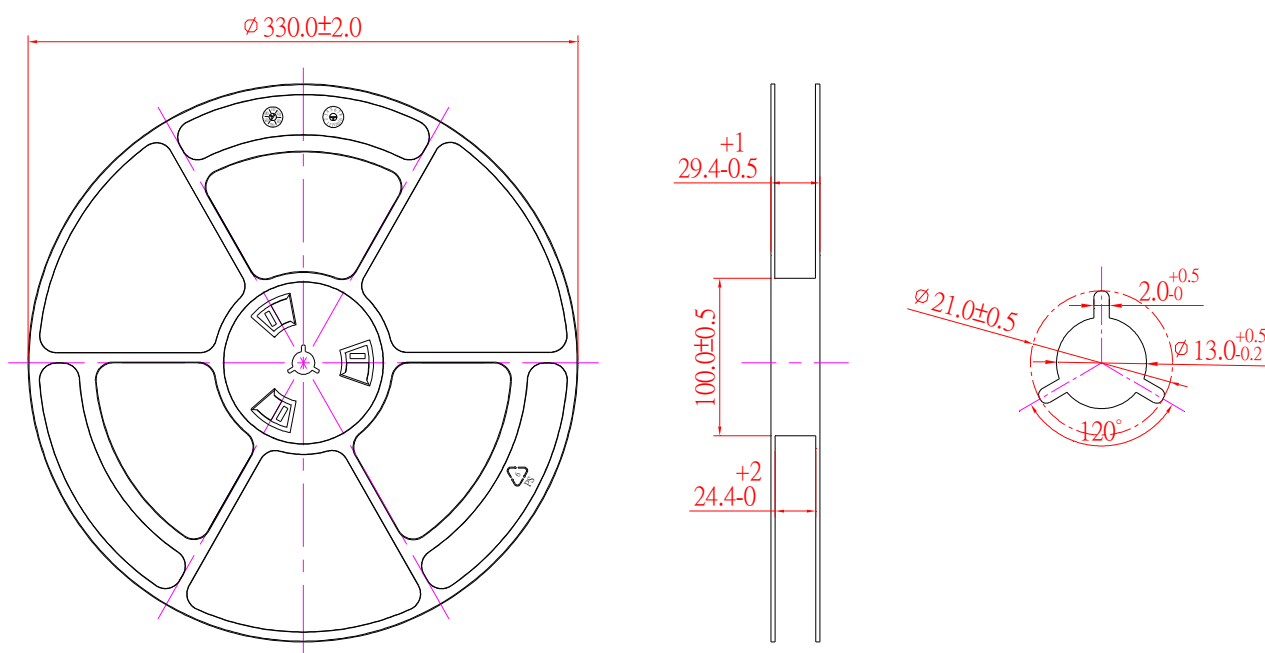
7. Recommended Soldering Pattern



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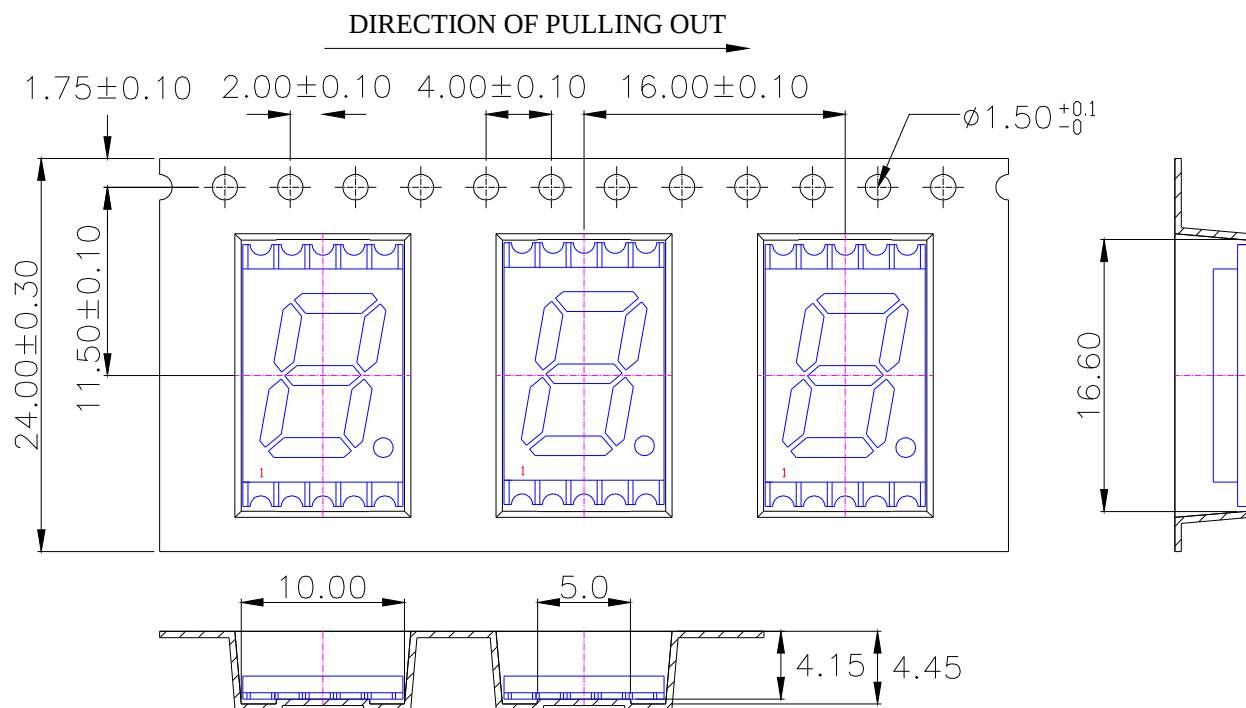
8. Packing Specification

8.1. Packing Reel Dimensions



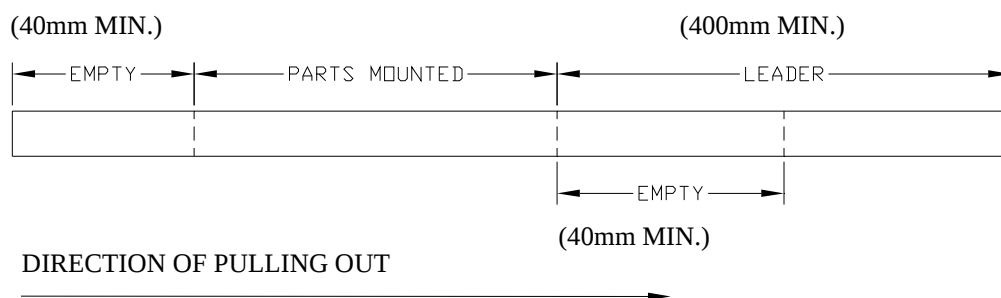
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8.2. Packing Carrier Dimensions



1. 10 sprocket hole pitch cumulative tolerance ± 0.20 .
2. Carrier camber is within 1 mm in 250 mm.
3. All dimensions meet EIA-481-C requirements.
4. Thickness : 0.40 ± 0.05 mm.
5. Packing length per 22" reel : 45.50 Meters.
6. Component load per 13" reel : 800 pcs.
7. Minimum packing quantity is 200 pcs for remainders

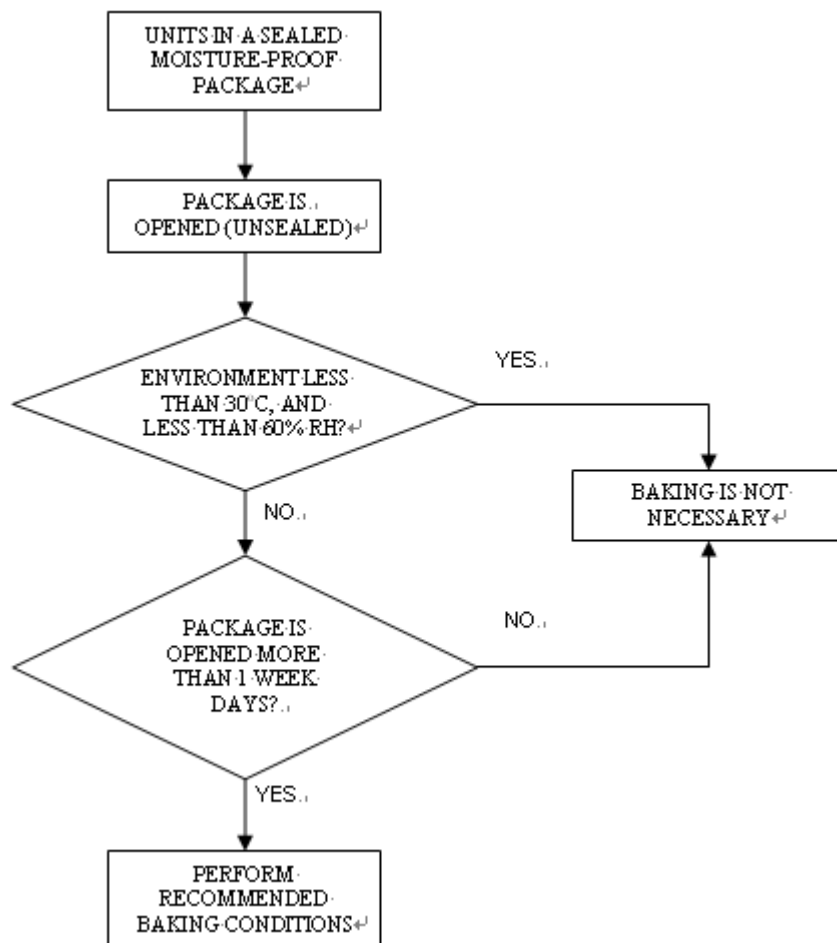
8.3. Trailer part / Leader part



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9. Moisture Proof Packing

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30°C or less and 60 % RH or less. Once the package opened, moisture absorption begins.



If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts. Baking should only be done once

Package	Temperature	Time
In Reel	60°C	≥ 48hours
In Bulk	100°C	≥ 4hours
	125°C	≥ 2hours

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10. CAUTIONS

10.1. Application

- The display described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the display may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).
- When using this LED display, please make sure absolute maximum ratings and the instructions for using outlined in these specification sheets. LITEON will not be responsible for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.
- The driving circuit should be designed to protect the LEDs inside the display against reverse voltages and transient voltage spikes when the circuit is powered up or shut down.
- Constant current driving is recommended to ensure consistent performance.
- Circuit design must cater to the whole range of forward voltage (VF) of the LEDs inside the display to ensure the intended drive current can always be achieved.
- The safe operating current should be chosen after considering the maximum ambient temperature of the operating environment.
- Reverse bias should be avoided, as it could cause metal migration, leading to an increase in leakage current or causing a short circuit.
- Avoid rapid changes in ambient temperatures, especially in high-humidity environments, because they cause condensation on the LED/LED display.
- Do not use unsuitable tool or assembly method to have abnormal force on display body cause damage.
- Printing/pattern film is using pressure sensitive glue to stick on LED display surface, not recommend to let LED display pattern film side close contact with front panel/cover, since the printing/pattern film may shift or moved from original position by external force.
- Recommend choose same BIN LED display while you assemble 2 or above 2 pcs LED display for one set application to avoid hue uneven problems.

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10.2. Storage conditions

- LED Display standard storage condition.

Product in the original packaging material state is recommended storage conditions.

Temperature Condition: 5°C~30°C

Humidity Condition: Below 60%RH

If the storage conditions do not meet specification standards, the LED display pins may become oxidized requiring re-plating and re-sorting before use. Suggest customers consume display as soon as possible, and avoid long-term storage of large inventories. If unseal package over 6 months, it is recommended baking at 60°C for 48 hours, and assembly within a week.

- LED SMD Display standard storage condition

When the package is in factory original sealed bag.

Temperature Condition: 5°C~30°C

Humidity Condition: Below 60%RH

When the package is opened and not in factory original sealed bag.

Temperature Condition: 5°C~30°C

Humidity Condition: Below 60%RH

Storage time: Within 168Hr (MSL as level 3)

If the storage conditions do not meet specification standards, the LED display pins or soldering pads may become oxidized requiring re-plating and re-sorting before use. Suggest customers consume display as soon as possible, and avoid long-term storage of large inventories.

- Recommend to baking the LEDs at 60 °C for 24hrs before soldering process if the LED SMD Display were unpacked more than 168hrs.
- Recommend using sealed package within 12 months from date code.
- The Displays should not be exposed to an environment where high level of moisture or corrosive gases are present.
- LED display pins and soldering pads are plated with gold, tin, or other metals. Under long-term exposure to open air, the exposed pins and pads may become oxidized causing poor solderability. Therefore opened but unused parts must be stored in sealed containers or controlled environment. Suggest to store unused SMD Display parts in the original moisture barrier bag and sealed.
- Moisture control for components already mounted on PCB
If the PCB will not undergo additional reflow soldering or high-temperature processes, then no special treatment is required for the mounted moisture-sensitive SMD components. If the PCB will undergo multiple reflow soldering or other high-temperature processes, including rework, then the SMD component's cumulative exposure time until the final high-temperature process must be controlled to within the specified time limit.

10.3. Cleaning

- Do not use unspecified chemical liquid to clean display they could harm the package.

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10.4. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage LED inside the display.

Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LED displays.
- All devices, equipment, and machinery, working tables, storage racks, etc. must be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED display plastic as a result of friction between LED display during storage and handling.

10.5. Terms and conditions for the usage of this document

- Keep same appearance and performance the contents of the product may be modified for productivity and reliability improvement without prior notice.
- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, LITEON will not be responsible for any subsequent issues.
- Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.
- The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with LITEON representative for further assistance.
- The contents and information of this document may not be reproduced or re-transmitted without permission by LITEON.
- When any special process such as potting is required for LED display assembly, please consult with LITEON representative before proceeding.
- Over-current-proof
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).